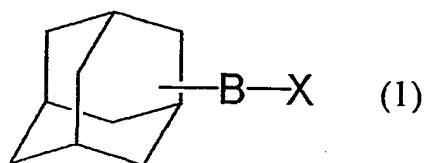


Abstract

The object of the present invention is to provide a novel compound which can prepare an insulating film having a low dielectric constant and excellent in the heat resistance. This object is achieved by an adamantane compound represented by the formula (1).



(wherein B represents a direct bond, an alkylene group having a carbon number of 1 to 6, an alkenylene group having a carbon number of 2 to 6, or an alkynylene group having a carbon number of 2 to 6, and X represents a monovalent organic group represented by the formula (2)).

